



US00D780154S

(12) **United States Design Patent**
Jaynes

(10) **Patent No.:** **US D780,154 S**

(45) **Date of Patent:** **** *Feb. 28, 2017**

(54) **HEADPHONE**

DESCRIPTION

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(72) Inventor: **Stephen R. Jaynes**, Pleasant Grove, UT (US)

(73) Assignee: **Wicked Audio, Inc.**, Lindon, UT (US)

(*) Notice: This patent is subject to a terminal disclaimer.

(**) Term: **14 Years**

(21) Appl. No.: **29/469,760**

(22) Filed: **Oct. 14, 2013**

(51) **LOC (10) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
USPC D14/205, 223; 181/129, 130, 135;
379/430, 431; 381/380, 381; 455/90.3,
(Continued)

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Primary Examiner — Paula Greene

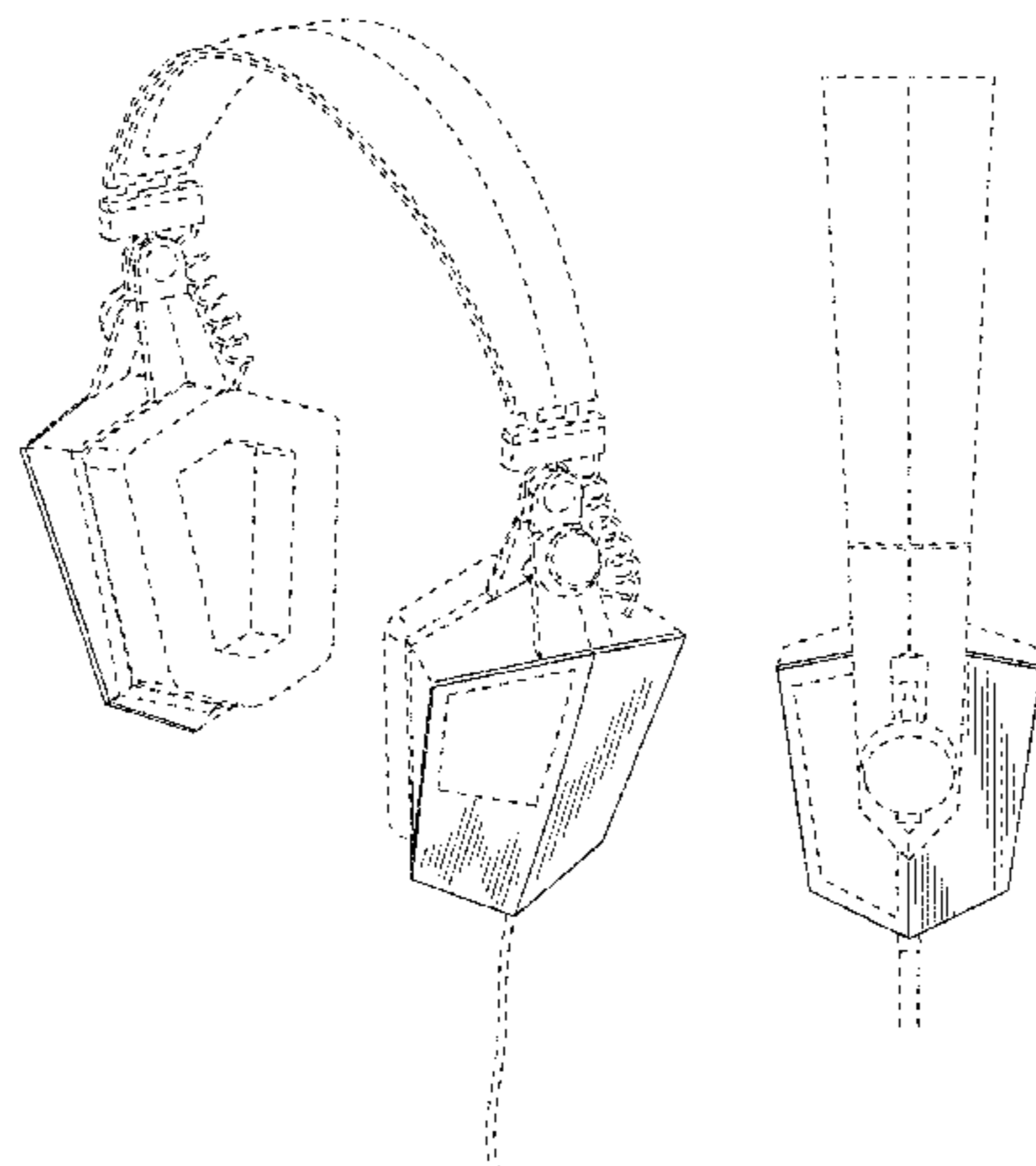
(74) *Attorney, Agent, or Firm* — Kirton McConkie; David B. Tingey; Bryant J. Keller

(57) **CLAIM**

The ornamental design for a headphone, as shown and described.

FIG. 1 is a perspective view showing a representative embodiment of my new design;
FIG. 2 is a front elevation view of the embodiment shown in FIG. 1;
FIG. 3 is a back elevation view of the embodiment shown in FIG. 1;
FIG. 4 is a left, side elevation view of the embodiment shown in FIG. 1;
FIG. 5 is a right, side elevation view of the embodiment shown in FIG. 1;
FIG. 6 is a top plan view of the embodiment shown in FIG. 1;
FIG. 7 is a bottom plan view of the embodiment shown in FIG. 1;
FIG. 8 is a perspective view showing another representative embodiment of my new design;
FIG. 9 is a front elevation view of the embodiment shown in FIG. 8;
FIG. 10 is a back elevation view of the embodiment shown in FIG. 8;
FIG. 11 is a left, side elevation view of the embodiment shown in FIG. 8;
FIG. 12 is a right, side elevation view of the embodiment shown in FIG. 8;
FIG. 13 is a top plan view of the embodiment shown in FIG. 8;
FIG. 14 is a bottom plan view of the embodiment shown in FIG. 8;
FIG. 15 is a perspective view showing another representative embodiment of my new design;
FIG. 16 is a back elevation view of the embodiment shown in FIG. 15;
FIG. 17 is a front elevation view of the embodiment shown in FIG. 15;
FIG. 18 is a right, side elevation view of the embodiment shown in FIG. 15;
FIG. 19 is a left, side elevation view of the embodiment shown in FIG. 15;
FIG. 20 is a top plan view of the embodiment shown in FIG. 15; and,
FIG. 21 is a bottom plan view of the embodiment shown in FIG. 15.

(Continued)



Representative embodiments of optional support structures are shown in broken lines for illustration purposes only and form no part of the claimed design.

1 Claim, 15 Drawing Sheets

(58) **Field of Classification Search**

USPC 455/575.1; D29/112; 24/113 R, 102 PL, 24/299.01, 124.11; D11/202; D2/607, D2/609; 2/245, 145

CPC H04R 25/00
See application file for complete search history.

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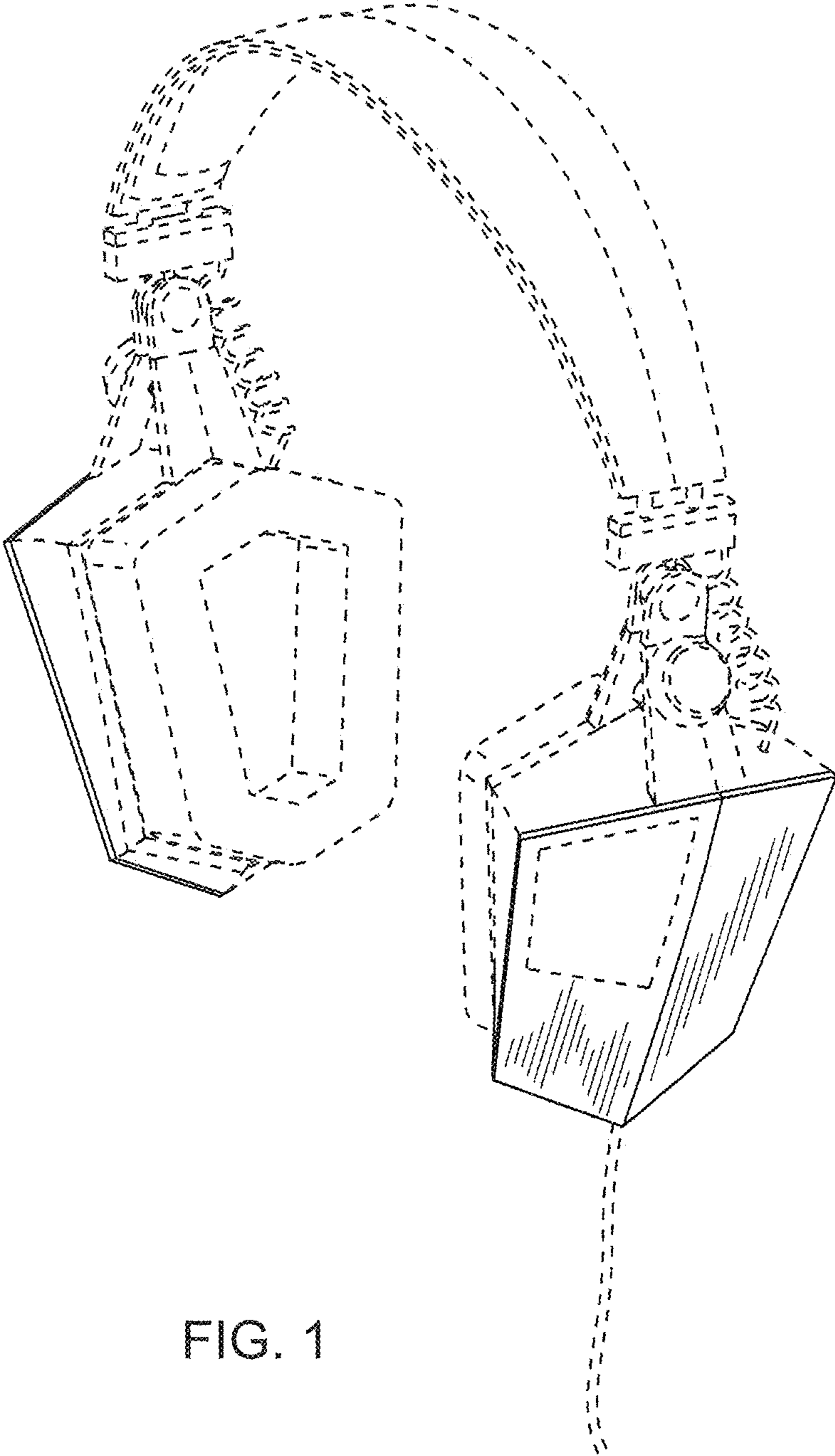


FIG. 1



FIG. 2



FIG. 3

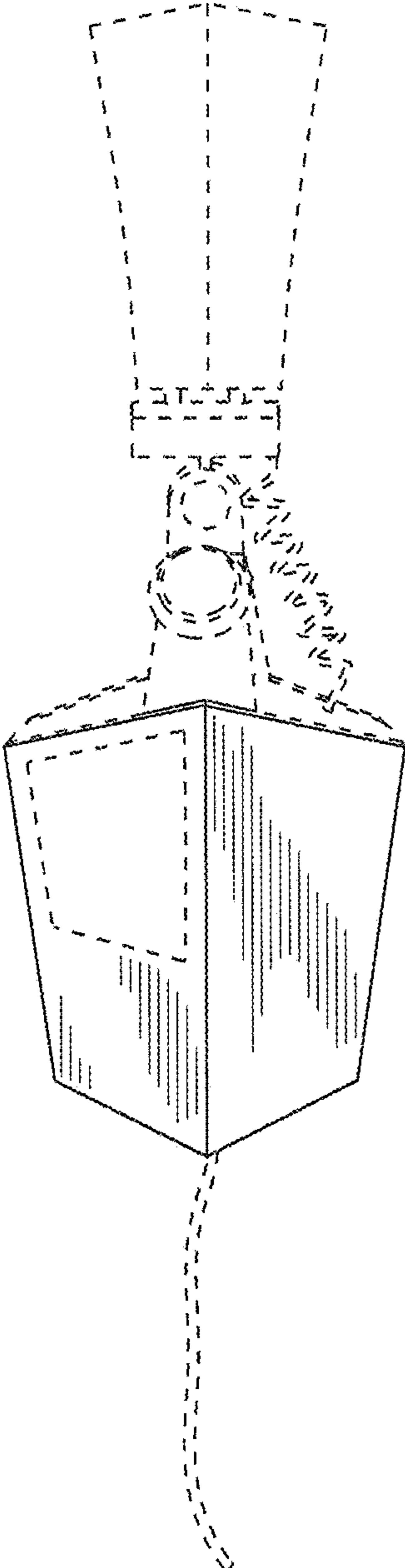


FIG. 4

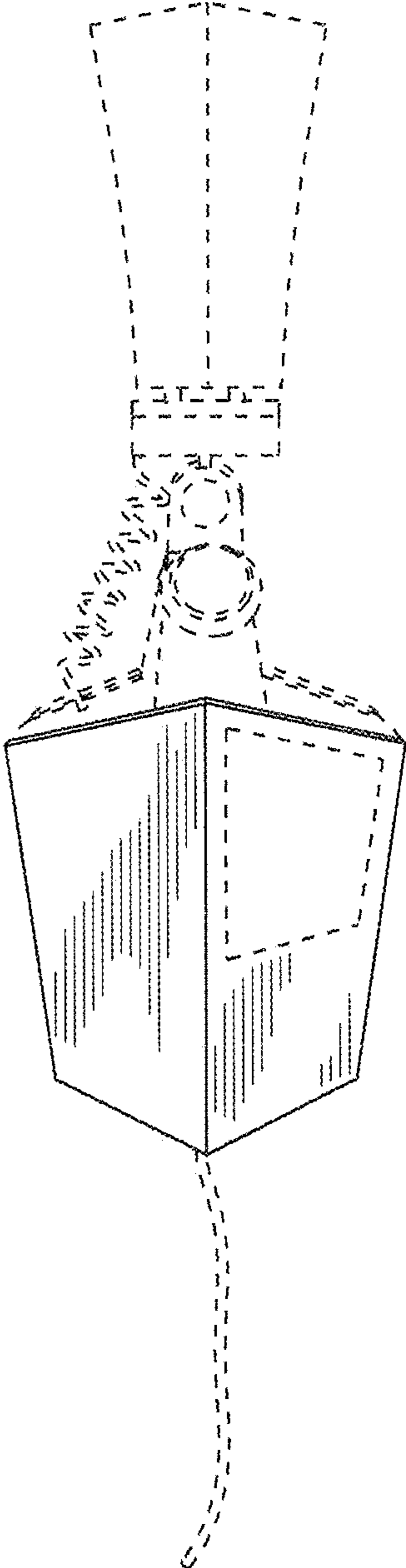


FIG. 5

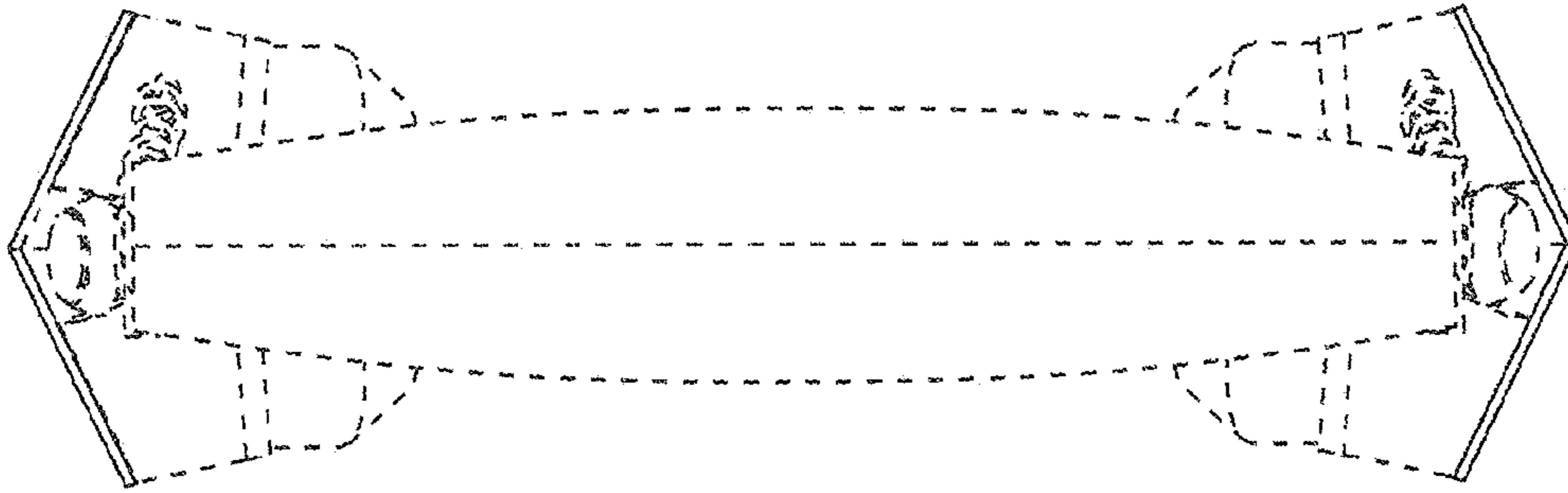


FIG. 6

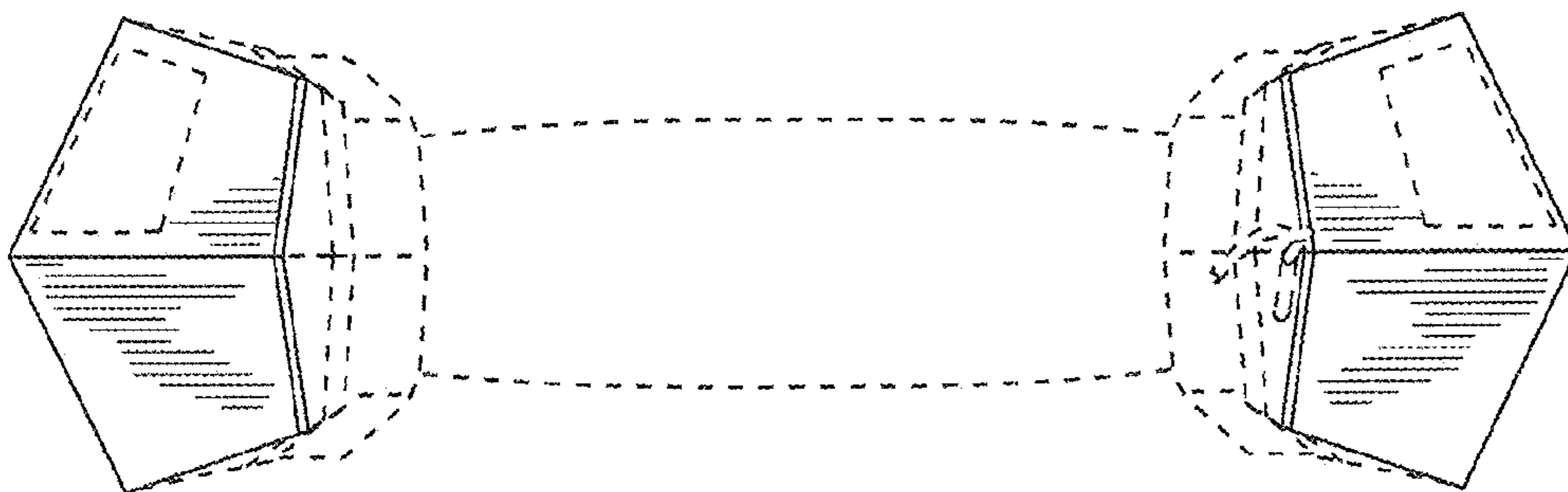


FIG. 7

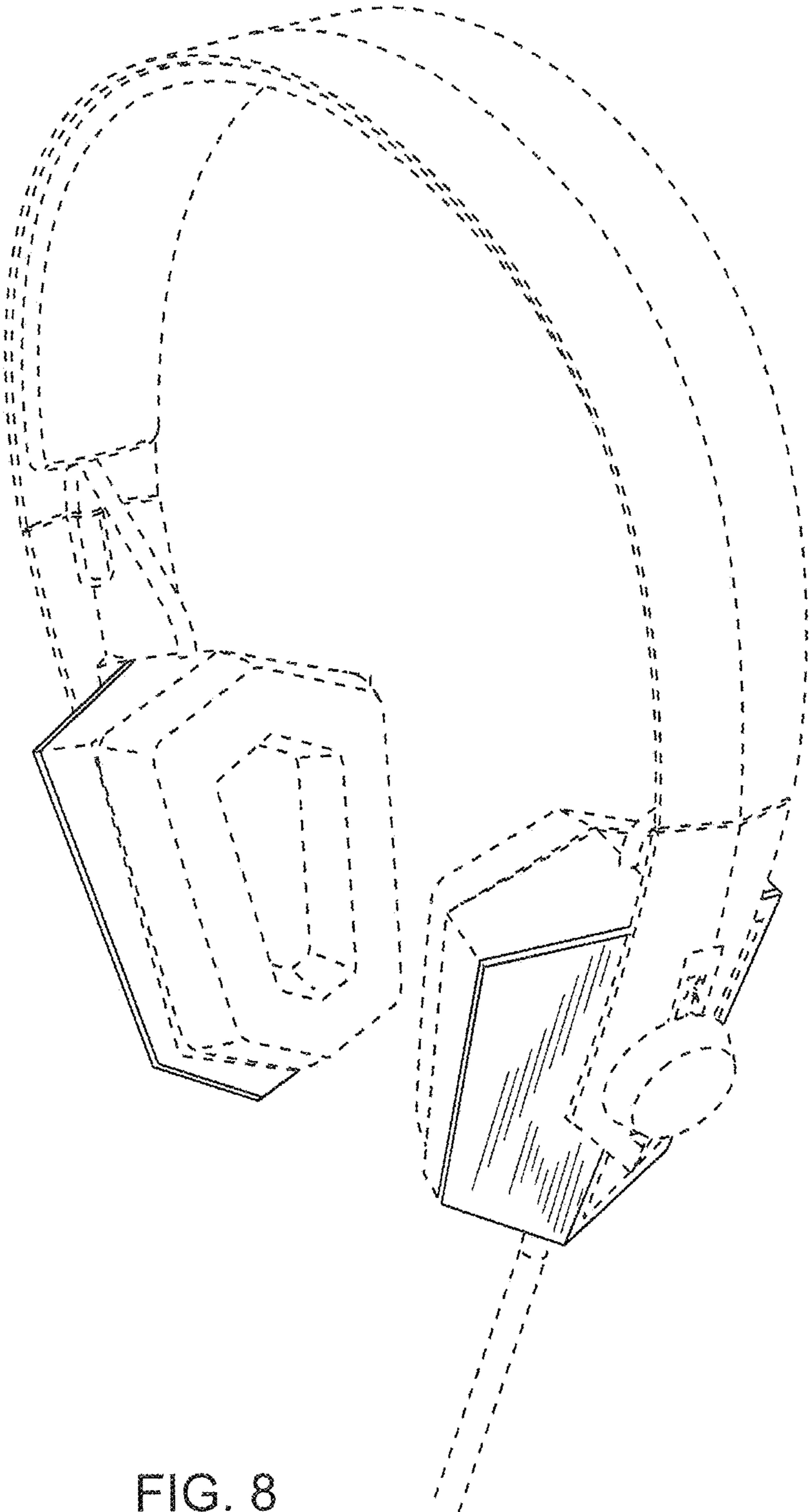


FIG. 8

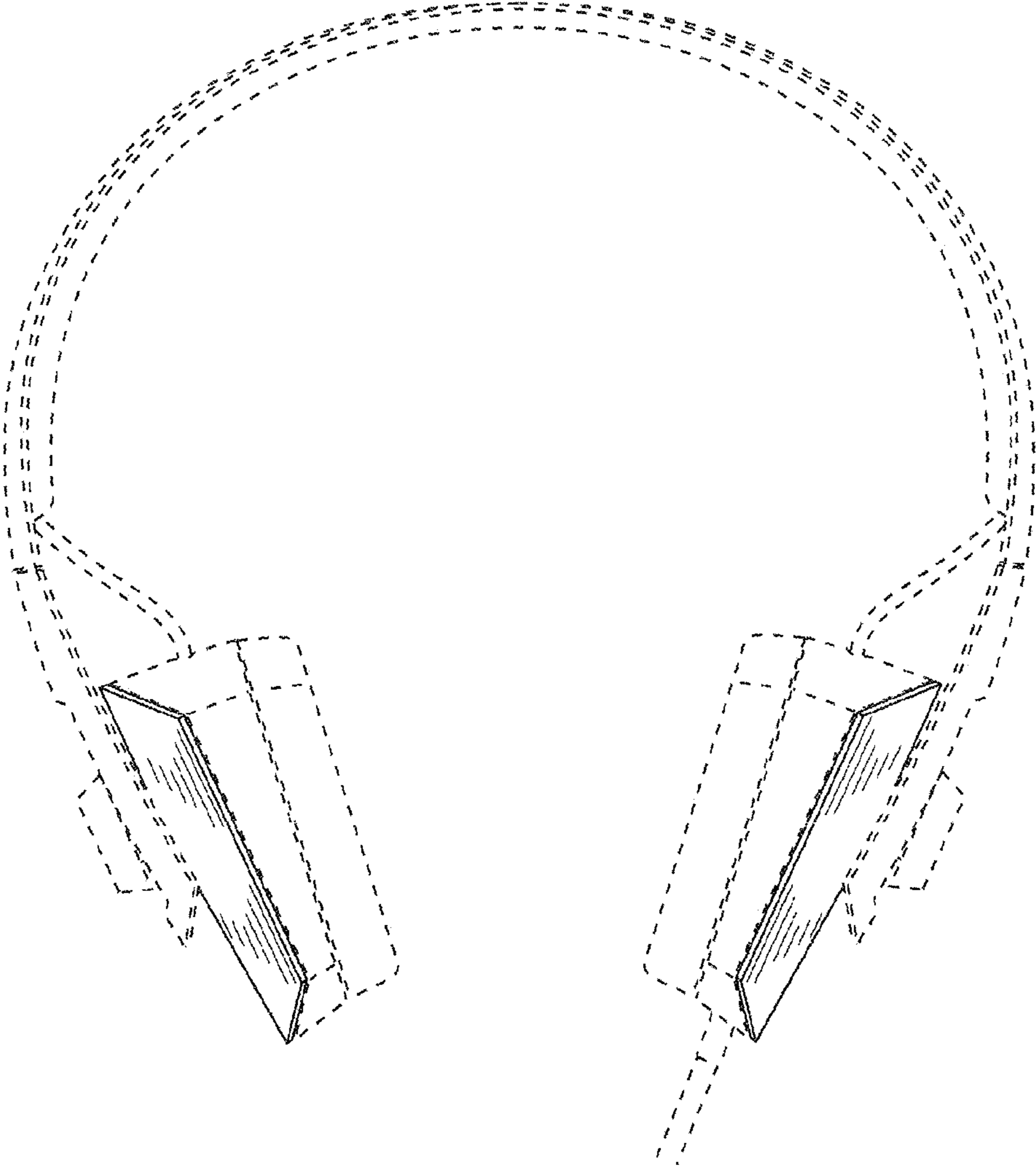


FIG. 9

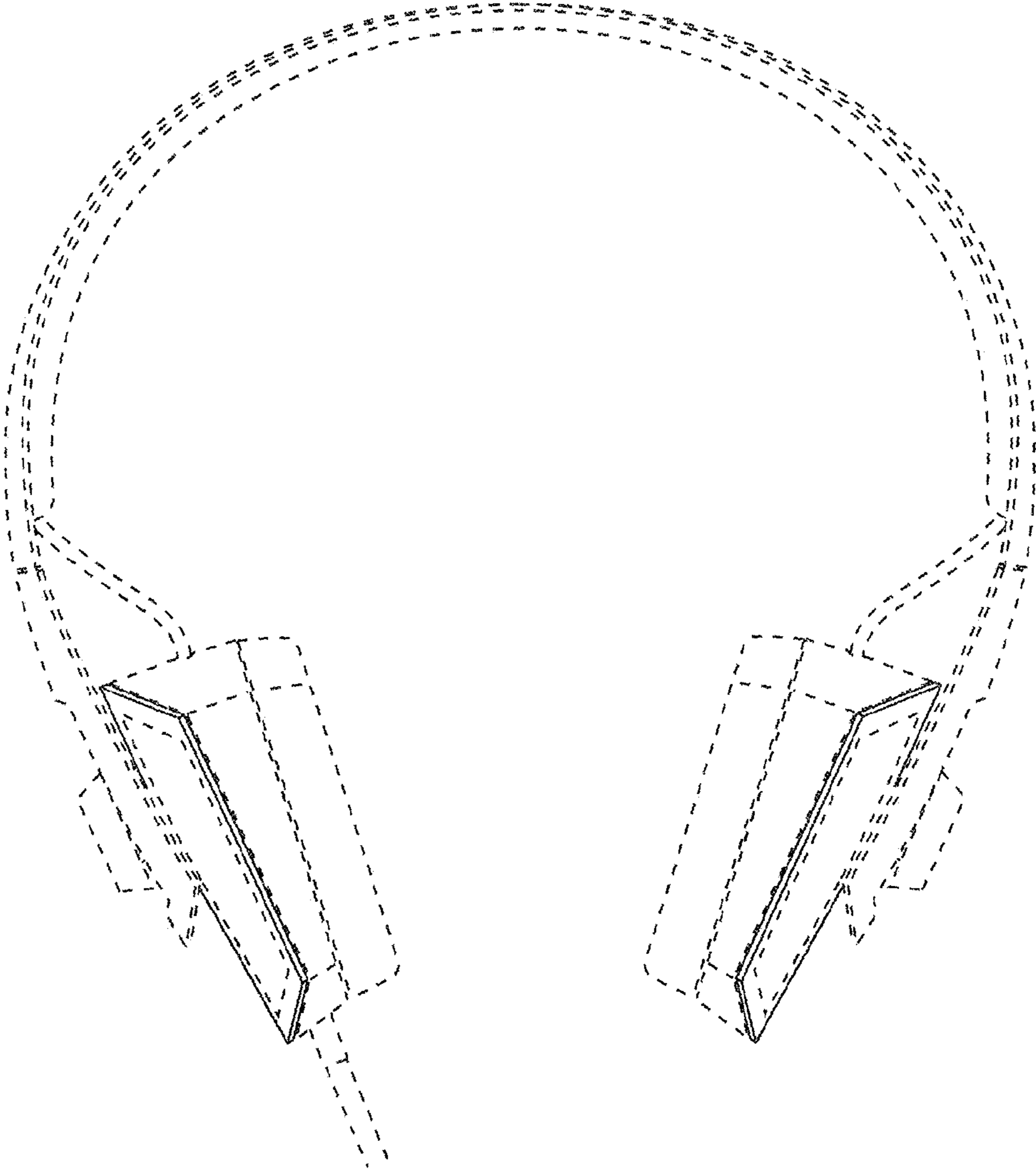


FIG. 10

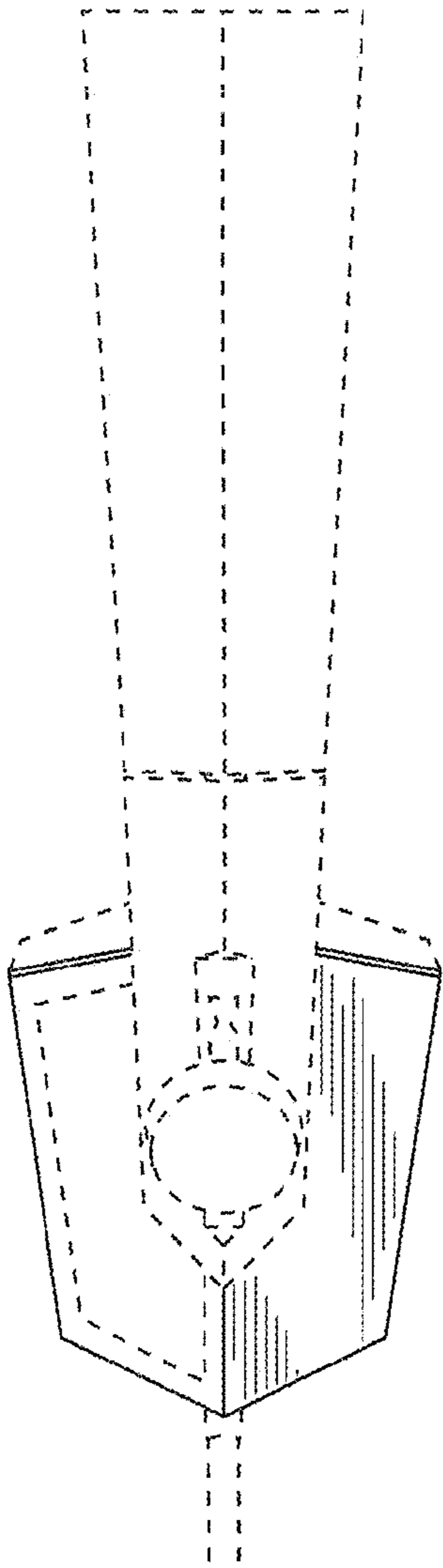


FIG. 11

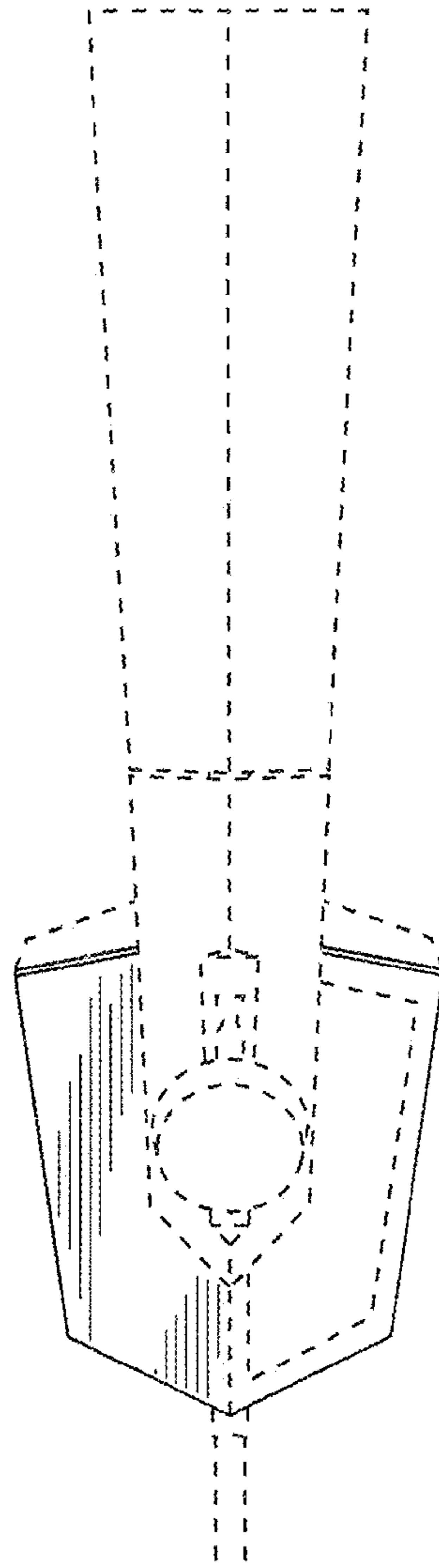


FIG. 12

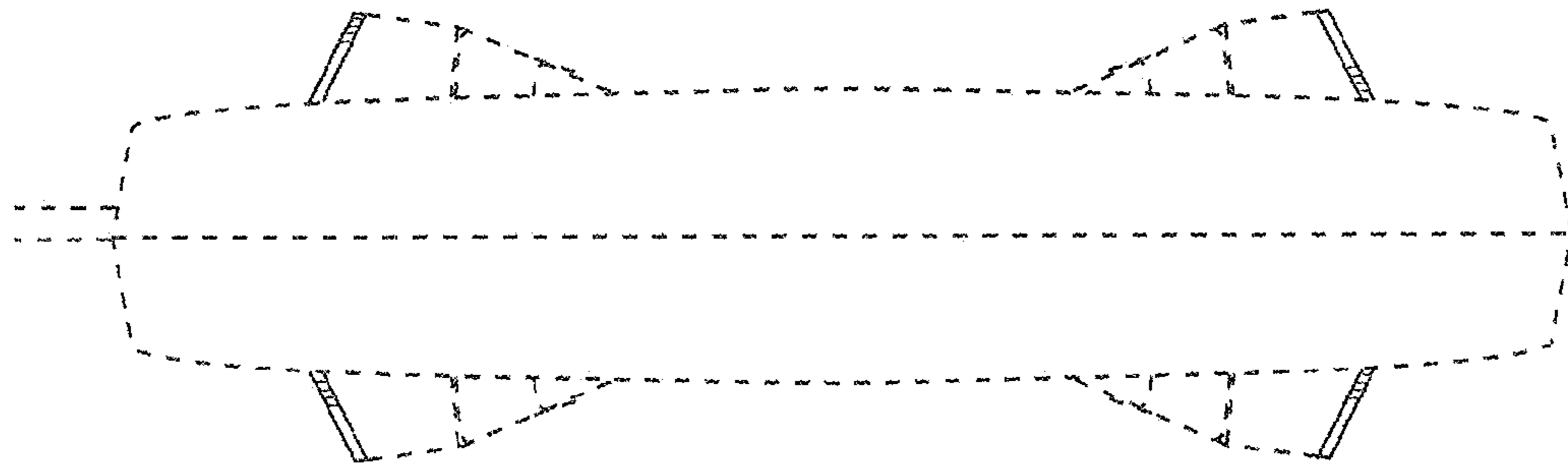


FIG. 13

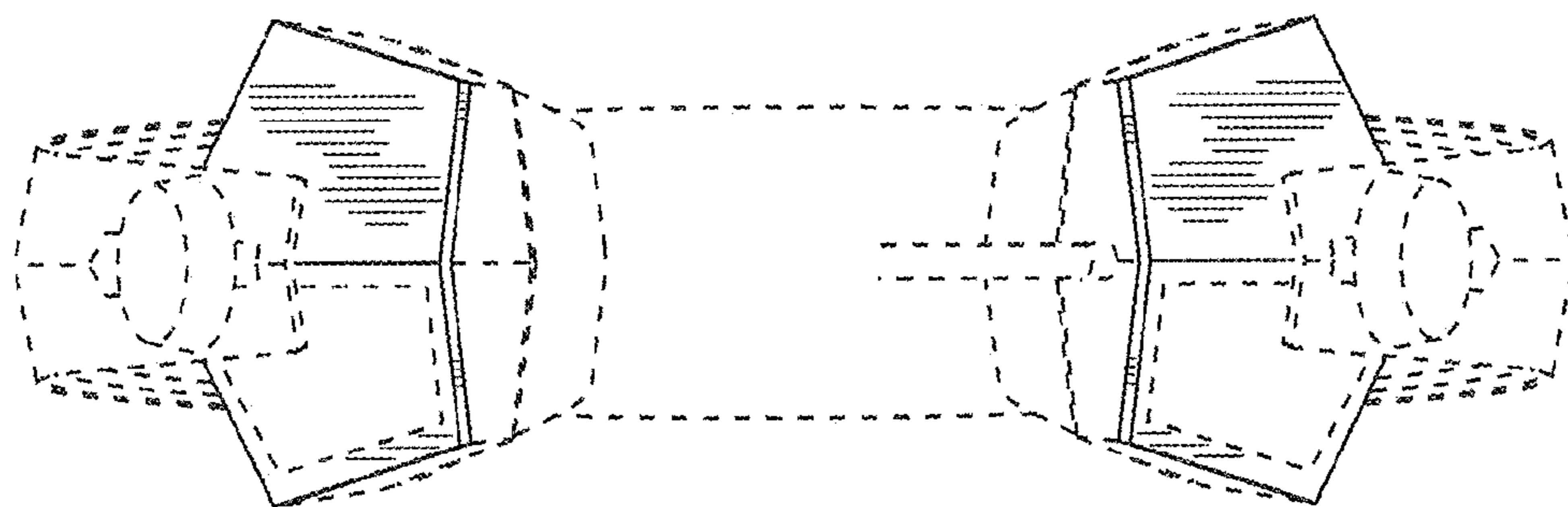


FIG. 14

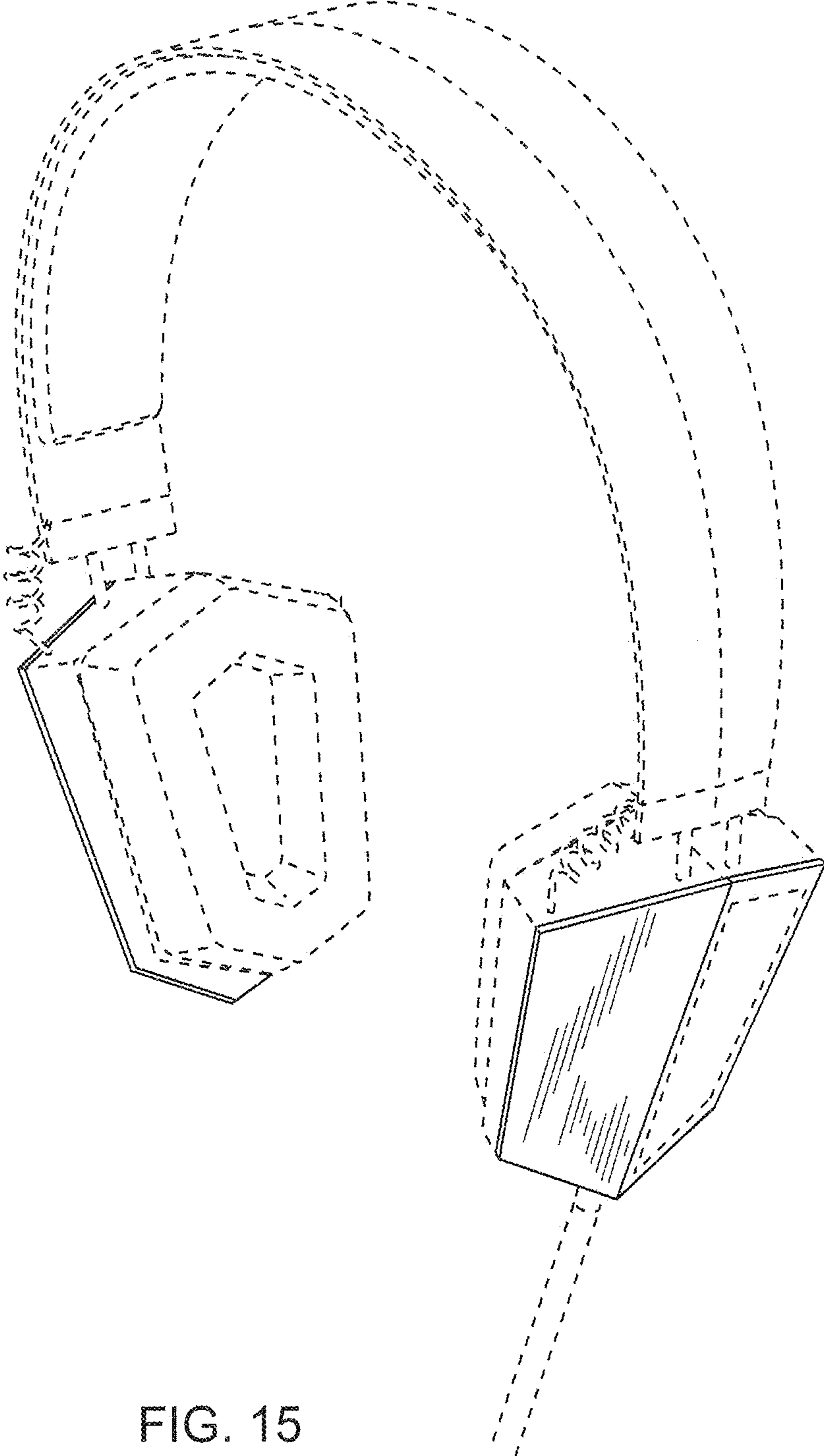


FIG. 15



FIG. 16

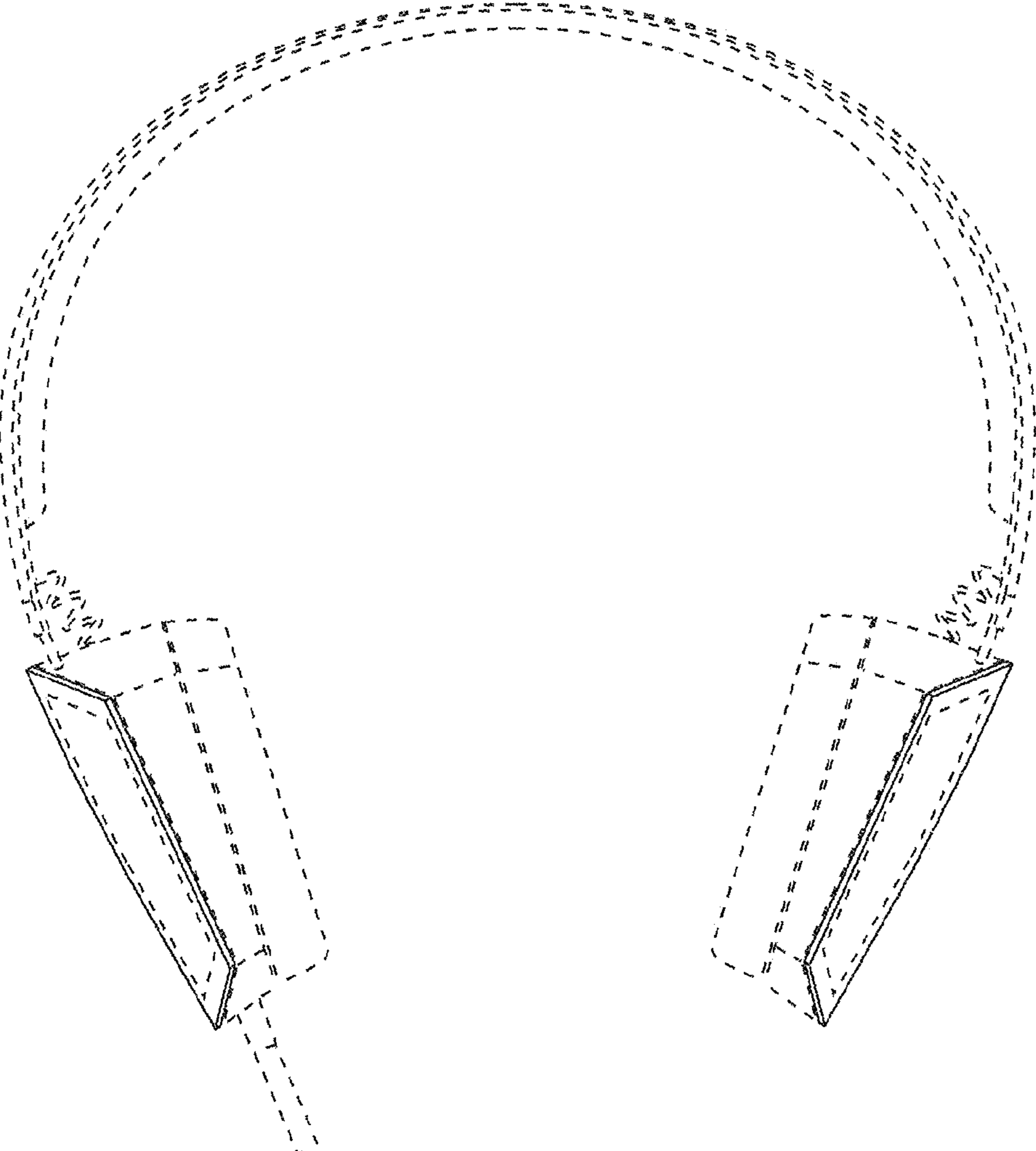


FIG. 17

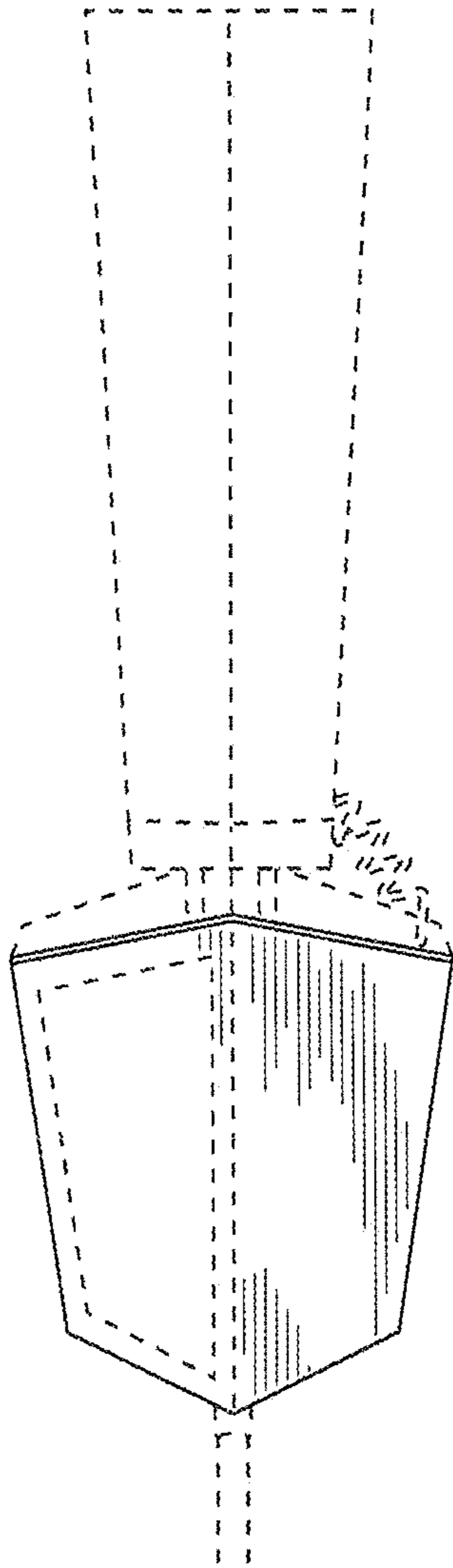


FIG. 18

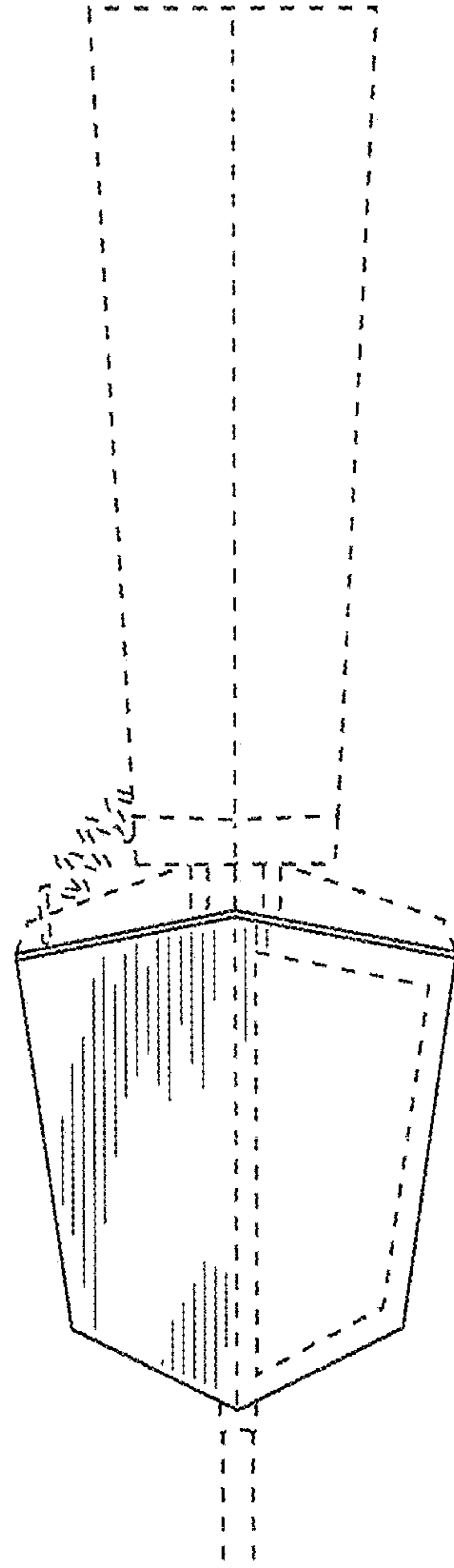


FIG. 19

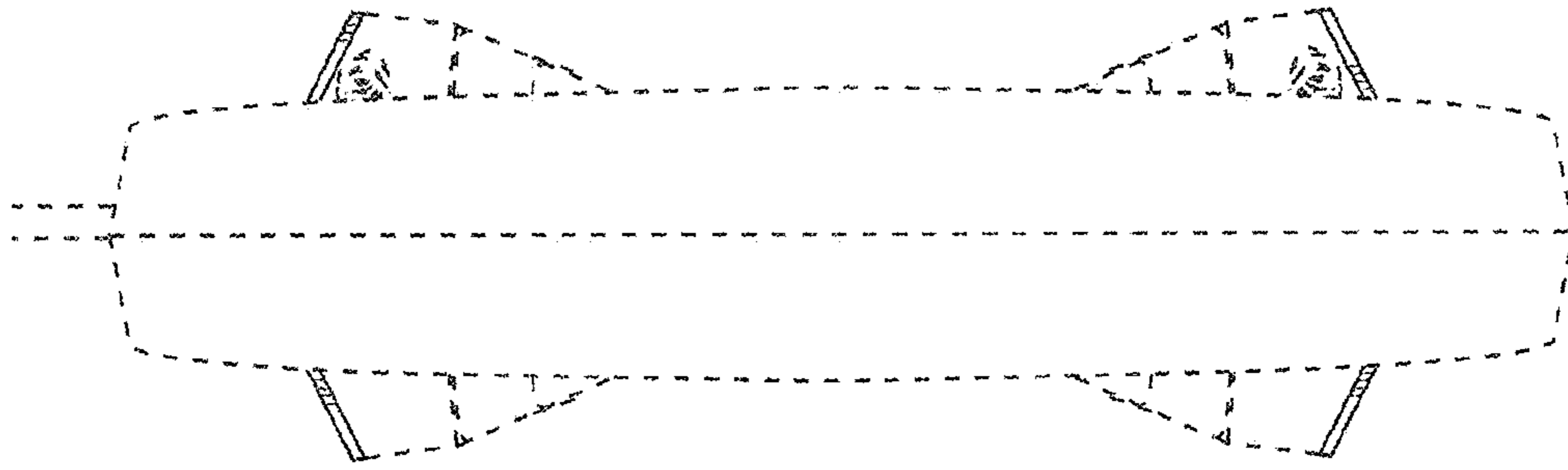


FIG. 20

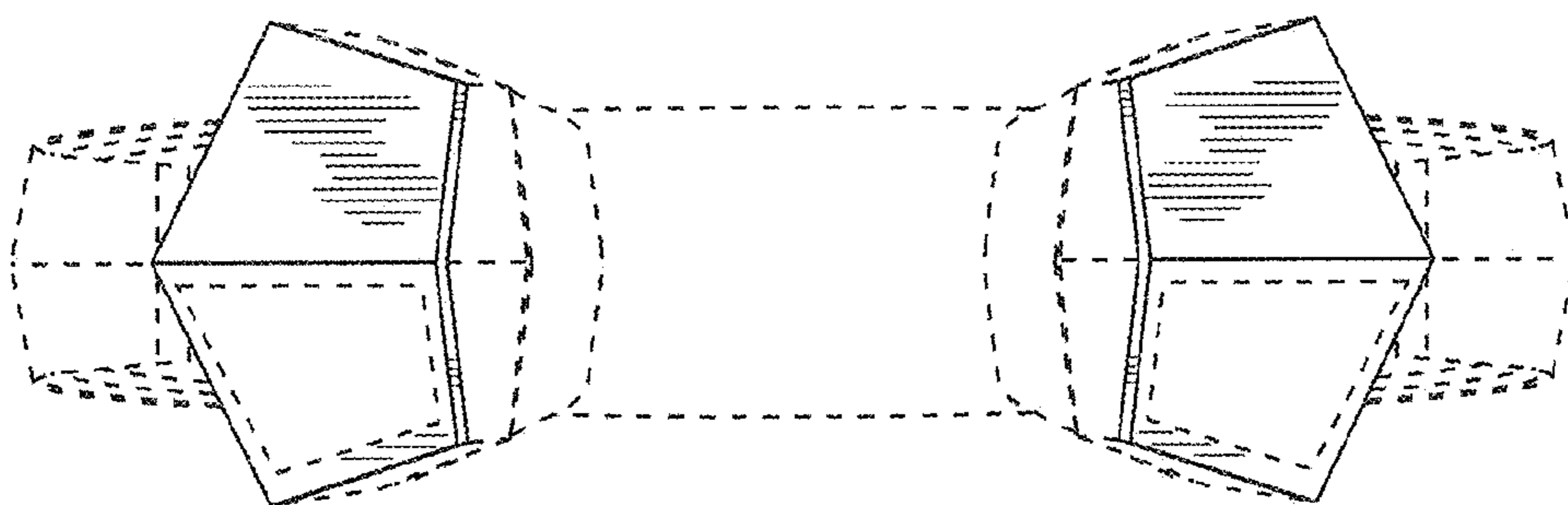


FIG. 21